





### 100V PNP LED DRIVING TRANSISTOR IN SOT89

### **Features**

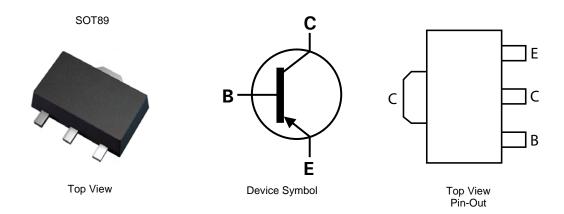
- BV<sub>CEO</sub> > -100V
- Maximum continuous current I<sub>C</sub> = -1A
- $h_{FE} > 100 @ I_C = -150 mA, V_{CE} = -0.2 V$
- Lead Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

## Applications

LED TV backlight

### **Mechanical Data**

- Case: SOT89
- Case material: molded Plastic. "Green" molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.052 grams (Approximate)



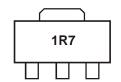
## Ordering Information (Note 3)

| Product     | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|-------------|---------|--------------------|-----------------|-------------------|
| ZXTP4003ZTA | 1R7     | 7                  | 12              | 1000 units        |

Notes:

- 1. No purposefully added lead.
- 2. "Green" devices, Halogen and Antimony Free, Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com
- 3. For Packaging Details, go to our website at http://www.diodes.com.

## **Marking Information**



1R7 = Product type Marking Code



### Maximum Ratings @TA = 25°C unless otherwise specified

| Characteristic               | Symbol           | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage       | V <sub>CBO</sub> | -100  | V    |
| Collector-Emitter Voltage    | V <sub>CEO</sub> | -100  | V    |
| Emitter-Base Voltage         | V <sub>EBO</sub> | -7    | V    |
| Continuous Collector Current | Ic               | -1    | А    |
| Peak Pulse Current (Note 4)  | I <sub>CM</sub>  | -3    | Α    |
| Base Current                 | I <sub>B</sub>   | -500  | mA   |

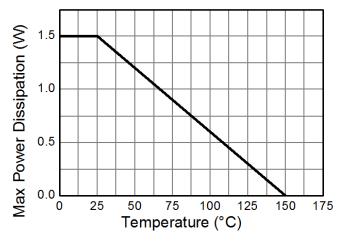
## Thermal Characteristics @TA = 25°C unless otherwise specified

| Characteristic                                   | Symbol                           | Value       | Unit |
|--|----------------------------------|-------------|------|
| Power Dissipation (Note 5)                       | P <sub>D</sub>                   | 1.5         | W    |
| Thermal Resistance, Junction to Ambient (Note 5) | $R_{	heta JA}$                   | 83          | °C/W |
| Thermal Resistance, Junction to Leads (Note 6)   | R <sub>θJL</sub>                 | 17.46       | °C/W |
| Operating and Storage Temperature Range          | T <sub>J.</sub> T <sub>STG</sub> | -55 to +150 | °C   |

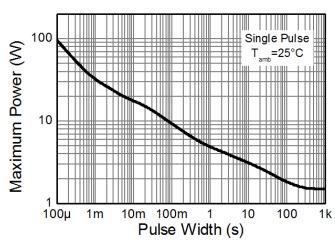
Notes:

- 4. Measured under pulsed conditions. Pulse width = 300µs. Duty cycle ≤ 2%.
- 5. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions
- 6. Thermal resistance from junction to solder-point (on the exposed collector pad).

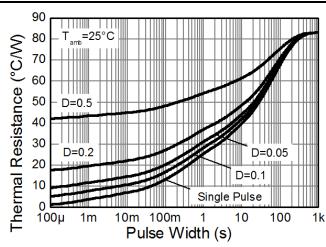
### Thermal Characteristics and Derating Information



# **Derating Curve**



# **Pulse Power Dissipation**



**Transient Thermal Impedance** 

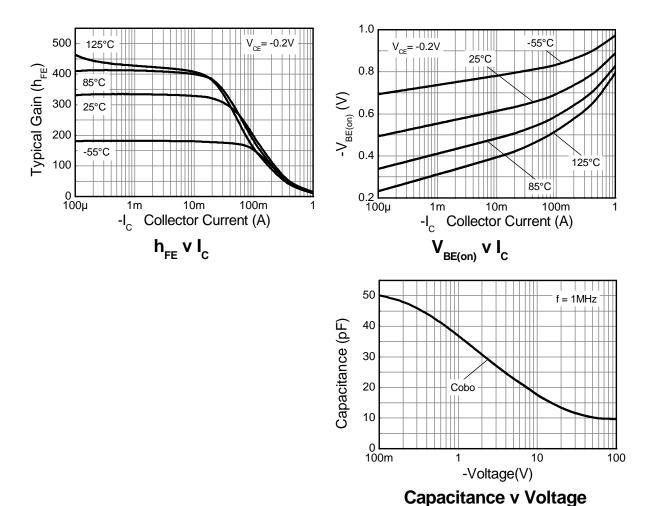


### Electrical Characteristics @TA = 25°C unless otherwise specified

| Characteristic                                 | Symbol              | Min       | Тур        | Max   | Unit | Test Condition   |
|--|---------------------|-----------|------------|-------|------|--|
| Collector-Emitter Breakdown Voltage (Note 7)   | BV <sub>CEO</sub>   | -100      | -170       | -     | V    | $I_C = -10 \text{mA}$  |
| Collector Cut-off Current                      | I <sub>CBO</sub>    | -         | -          | -50   | nA   | V <sub>CB</sub> = -100V  |
| Emitter Cut-off Current                        | I <sub>EBO</sub>    | -         | -          | -50   | nA   | $V_{EB} = -7V$   |
| Static Forward Current Transfer Ratio (Note 7) | h <sub>FE</sub>     | 60<br>100 | 133<br>112 | -     | -    | $I_C = -85 \text{mA}, V_{CE} = -0.15 \text{V}$<br>$I_C = -150 \text{mA}, V_{CE} = -0.2 \text{V}$ |
| Base-Emitter Turn-On Voltage (Note 7)          | V <sub>BE(on)</sub> | -         | -0.71      | -0.95 | V    | $I_C = -150 \text{mA}, V_{CE} = -0.2 \text{V}$   |
| Delay Time                                     | t <sub>(d)</sub>    | -         | 378        | -     | ns   |  |
| Rise Time                                      | t <sub>(r)</sub>    | -         | 388        | -     | ns   | $V_{CC} = -80V, I_{C} = -150mA,f$  |
| Storage Time                                   | t <sub>(s)</sub>    | -         | 1348       | -     | ns   | $-I_{B2} = 1.5 \text{mA}, V_{CE(ON)} = -0.2 \text{V}$  |
| Fall Time                                      | t <sub>(f)</sub>    | -         | 382        | -     | ns   |  |
| Storage Time                                   | t <sub>(s)</sub>    | -         | 75         | -     | ns   | $V_{CC} = -80V, I_{C} = -150mA,$   |
| Fall Time                                      | t <sub>(f)</sub>    | -         | 363        | -     | ns   | $-I_{B2} = -1.5$ mA, $V_{CE(ON)} = -4$ V   |

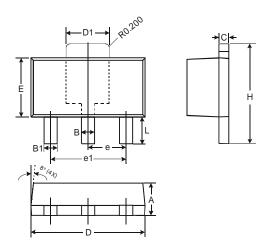
Notes: 7. Measured under pulsed conditions. Pulse width =  $300\mu s$ . Duty cycle  $\leq 2\%$ 

# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified



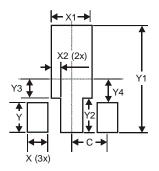


# **Package Outline Dimensions**



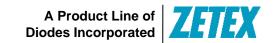
| SOT89                |                   |      |  |  |
|----------------------|-------------------|------|--|--|
| Dim                  | Min               | Max  |  |  |
| Α                    | 1.40              | 1.60 |  |  |
| В                    | 0.44              | 0.62 |  |  |
| B1                   | 0.35              | 0.54 |  |  |
| С                    | 0.35              | 0.43 |  |  |
| D                    | 4.40              | 4.60 |  |  |
| D1                   | 1.52              | 1.83 |  |  |
| E                    | 2.29              | 2.60 |  |  |
| е                    | <b>e</b> 1.50 Typ |      |  |  |
| e1                   | 3.00 Typ          |      |  |  |
| Н                    | 3.94              | 4.25 |  |  |
| L                    | 0.89              | 1.20 |  |  |
| All Dimensions in mm |                   |      |  |  |

# **Suggested Pad Layout**



| Dimensions | Value (in mm) |  |  |  |
|------------|---------------|--|--|--|
| Х          | 0.900         |  |  |  |
| X1         | 1.733         |  |  |  |
| X2         | 0.416         |  |  |  |
| Υ          | 1.300         |  |  |  |
| Y1         | 4.600         |  |  |  |
| Y2         | 1.475         |  |  |  |
| Y3         | 0.950         |  |  |  |
| Y4         | 1.125         |  |  |  |
| С          | 1 500         |  |  |  |





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